

Sauls Wharf House Crittens Road Great Yarmouth Norfolk NR31 0AG Telephone +44 (0)1493 602602 Email:sales@midasdisplays.com Email:tech@midasdisplays.com www.midasdisplays.com

MDT0096A2IS-SPI	80 x 160	SPI Interface	TFT Module	
		Specification		
Version: 1		Date: 01/10/2017		
		Revision		
1 2	9/09/2017	First issue		

Display F	eatures		
Display Size	0.96"		
Resolution	80 x 160		
Orientation	Portrait		
Appearance	RGB		
Logic Voltage	2.8V		oHS ompliant
Interface	SPI		$(0) \vdash S$
Brightness	350 cd/m <sup>2</sup>	/ Y = 33	mpliant
Touchscreen	SPLA	1 500	mpnant
Module Size	13.30 x 27.948 x 1.4mm		10%
Operating Temperature	-20°C ~ +70°C		
Pinout	13 way FFC	Box Quantity	Weight / Display
Pitch	0.7mm		

\* - For full design functionality, please use this specification in conjunction with the ST7735S specification.(Provided Separately)

Display Accessories						
Part Number	Description					

Optional Variants					
Appearances	Voltage				

# **General Description**

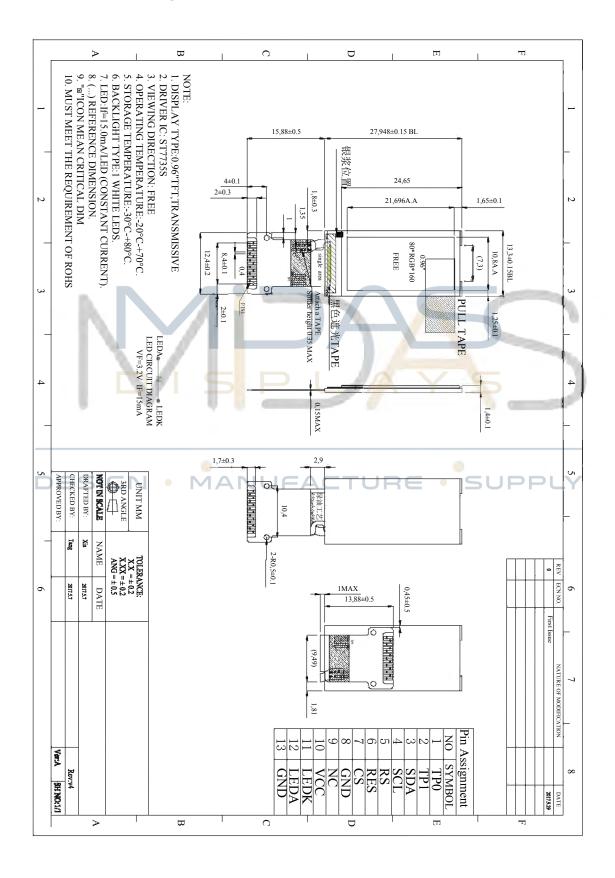
This display module is a transmissive type color active matrix TFT(Thin Film Transistor liquid crystal display (LCD that uses amorphous silicon TFT as a switching device. This module is composed of a TFT LCD module, a driver circuit, and a back-light unit. The resolution of a 0.96" contains 80(RGB)X160 dots and can display up to 65k colors.

### **Module Parameter**

Features	Details	Unit
Display Size(Diagonal)	0.96	inch
LCD type	α-Si TFT	-
Display Mode	IPS / Transmissive / Normally Black	-
Resolution	80RGB x 160	-
View Direction	All	Best image
Module Outline	$13.3(H) \times 27.948(V) \times 1.4(T)$ (Note 1)	mm
TP Outline	N/A	mm
TP Viewing Area	N/A	mm
TP Active Area	N/A	mm
Active Area	10.80 (H)×21.70(V)	mm
Viewing Area	N/A	mm
Display Colors	65K	-
Interface	4-SPI	-
Driver IC	ST7735S	-
Operating Temperature	-20~70 FACTURE • SU	PPL℃
Storage Temperature	-30~80	°C
Weight	TBD	g

Note 1: Excluding hooks, posts, FPC/FPC tail etc.

# **Mechanical Drawings**



# **Module Interface**

NO	SYMBOL	FUNCTION			
1	TP0	Touch Pin, If not used, please open this pin.			
2	TP1	Touch Pin ,If not used, please open this pin.			
3	SDA	SPI interface input/output pin. The data is latched on the rising edge of the SCL signal.			
4	SCL	This pin is used to be serial interface clock.			
5	D/C	Display data/command selection pin in 4-line serial interface.			
6	RESET	This signal will reset the device and it must be applied to properly initialize the chip. Signal is active low.			
7	CS	Chip selection pin; Low enable, High disable.			
8	GND	Power Ground			
9	NC	No Connect			
10	VDD	Power Supply for Analog, VDD=2.5V~3.3V.			
11	LEDK	LED Cathode			
12	LEDA	LED Anode			
13	GND	Power Ground			

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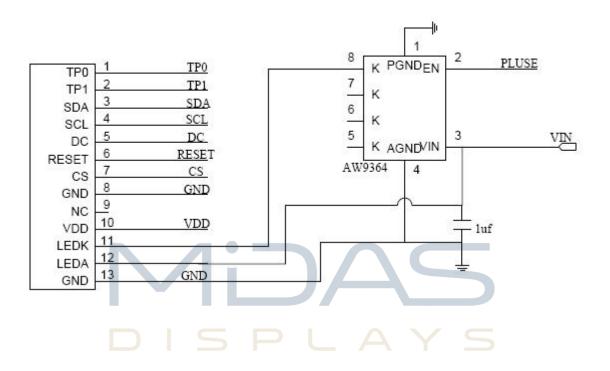
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# **Application Circuit**

#### **4-Line SPI Interface**

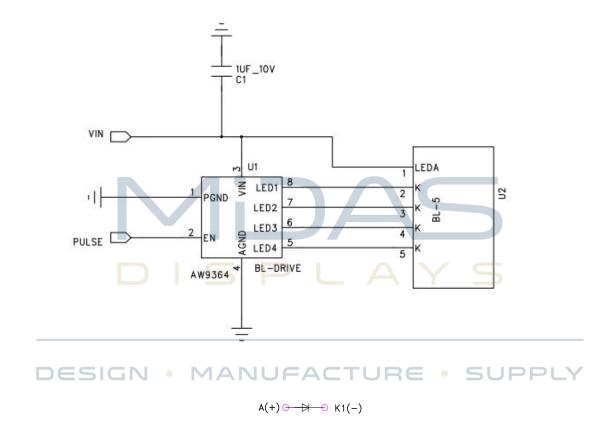


Note1: VIN=2.8V~5.5V.

Note2: EN pin signal control AW9364 working condition. When the EN pin signal is converted to high power, and the chip begins to work normally make it. AW9364 built-in shutdown delay circuit when EN pins letter switch from high level to low power and low level The delay of the shutdown of the chip is less than that of the die adjust the effect of LED output current size. When EN pins low electricity maintain time of more than 2ms, chip into shutdown mode.

### **Backlight recommended circuit**

Motherboard driver backlight is need constant current circuit, if the rated voltage screen after light brightness difference. Current and power consumption of the machine are inconsistent, so recommend a backlight driving circuit is best rated current. It is recommended to use IC (AW9364). The reference circuit is as follows:



Note: constant current circuit for every LED, and though LED lamp current is less than 20mA.Recommand between 15mA and 20 mA for every LED.

# **Absolute Maximum Ratings**

VSS=0V, Ta=25°C

Item		Symbol	Min.	Max.	Unit
	Power supply	VDD	-0.3	+4.6	V
Supply Voltage	Analog	-	-	-	V
	IO	IOVDD	-0.3	+4.6	V
Input Voltage	Input Voltage		-0.3	IOVDD+0.3	V
Storage temperature		$T_{stg}$	-30	+80	°C
Operating temperature		$T_{op}$	-20	+70	°C
Storage humidity		$H_{stg}$	10	Note 1	%RH
Operating humidity		$H_{op}$	10	Note 1	%RH

Note 1: 90%RH max, If Ta is below 50°C; 60%RH max, If Ta is over 60°C.

# **Electrical Specification**

DC Characteristics

Item	Symbol	Min.	Тур.	Max.	Unit	
	Power supply	VDD	2.4	2.8	3.3	V
Supply Voltage	Analog	VCI	2.4	2.8	3.3	V
	IO	IOVDD	1.65	1.8/2.8	3.3	V
Logic Low input voltage	ge	$V_{\rm IL}$	-0.3IOVDD	1	0.3IOVDD	V
Logic High input volta	ge	$V_{ m IH}$	0.7IOVDD	•	IOVDD	V
Logic Low output volta	age	$V_{OL}$		-	0.2IOVDD	V
Logic High output volt	age MANU	$V_{\mathrm{OH}}$	0.8IOVDD	Ñ,	ייבר	V
Normal display		Ivdd	-	15	-	mA
Current Consumption	Standby mode	Ivdd	-	9	-	uA
Frame Frequency	$f_{FR}$	=	60	-	Hz	

# **AC Characteristics**

Reset timing and interface timing:

Please refer to IC datasheet.

### **Command Table**

Please refer to IC datasheet.

# **Recommended Setting and Initialization Flow for Reference**

Please refer to attached file.

# **Optical Specifications**

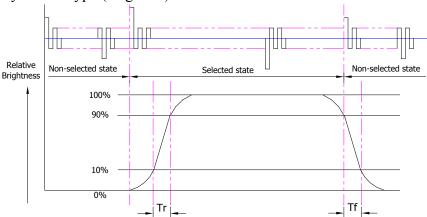
## 1. Optical Specifications

Ta=25°C, VDD=2.8V, TN LC+ Polarizer

Item			Symbol Condition		Specification			TT *4
	item		Symbol	Condition	Min.	Тур.	Max.	Unit
	Luminance on surface( $I_f = 15 \text{mA}$ )		Lv	Normally viewing	300	350	-	cd/m²
(a)	Contrast ra	atio	CR	angle $\theta_{x} = \theta_{y} = 0^{\circ}$	-	600	-	-
Backlight On (Transmissive Mode)	Response t	ime	$T_R$	$\sigma_X - \sigma_Y - \sigma$	-	10	20	ma
ive 1			$T_F$	1	ı	20	30	ms
nissi		Red	$X_R$		0.614	0.644	0.674	-
ansı		Red	$Y_R$	0.290	0.320	0.350	-	
	Chromaticity	Green	$X_G$	) /-	0.270	0.300	0.330	-
t On	Transmissive	Green	$Y_G$	_	0.540	0.570	0.600	-
ligh	Transmissive	Blue	$X_B$		0.104	0.134	0.164	-
ack		Bruc	$Y_B$		0.097	0.127	0.157	-
		White	Xw		0.267	0.297	0.327	-
		Willie	$Y_W$		0.302	0.332	0.362	
	Viewing	Horiz	$\theta_{X^+}$	JEACTU	JRE	80	JPPL	Y
	Angle	ontal	θх-	Center	-	80	-	Deg.
	mgic	Vertic	$\theta_{Y^+}$	CR≥10	-	80	-	Dog.
		al	θγ-		-	80	-	
	NTSC Ratio(C	Gamut)	-	-	-	60	-	%

#### 2. Definition of Response Time

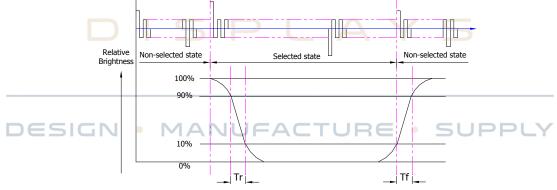
### 2.1 Normally Black Type (Negative)



Tr is the time it takes to change form non-selected state with relative luminance 10% to selected state with relative luminance 90%;

Tf is the time it takes to change from selected state with relative luminance 90% to non-selected state with relative luminance 10%.

### 2.2 Normally White Type (Positive)



Tr is the time it takes to change form non-selected state with relative luminance 90% to selected state with relative luminance 10%;

Tf is the time it takes to change from selected state with relative luminance 10% to non-selected state with relative luminance 90%;

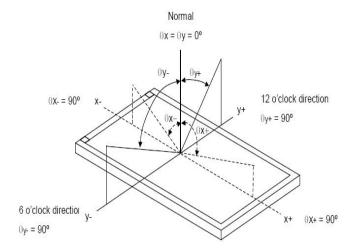
#### 3. Definition of Contrast Ratio

Contrast is measured perpendicular to display surface in reflective and transmissive mode. The measurement condition is:

Measuring Equipment	BM-7 or EQUI	
Measuring Point Diameter	3mm//1mm	
Measuring Point Location	Active Area centre point	
Test mettern	A: All Pixels white	
Test pattern	B: All Pixel black	
Contrast setting	Maximum	

Definitions: CR (Contrast) = Luminance of White Pixel / Luminance of Black Pixel

### 4. Definition of Viewing Angles



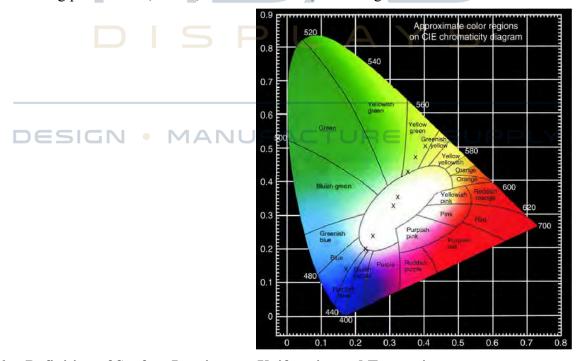
Measuring machine: LCD-5100 or EQUI

### 5. Definition of Color Appearance

R,G,B and W are defined by (x, y on the IE chromaticity diagram

NTSC=area of RGB triangle/area of NTSC triangleX100%

Measuring picture: Red, Green, Blue and White (Measuring machine: BM-7

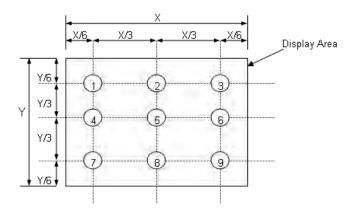


### 6. Definition of Surface Luminance, Uniformity and Transmittance

Using the transmissive mode measurement approach, measure the white screen luminance of the display panel and backlight.

- 6.1 Surface Luminance: LV = average (LP1:LP9)
- 6.2 Uniformity = Minimal (LP1:LP9) / Maximal (LP1:LP9) \* 100%
- 6.3 Transmittance = LV on LCD / LV on Backlight \* 100%

Note: Measuring machine: BM-7



# **Quality Assurance**

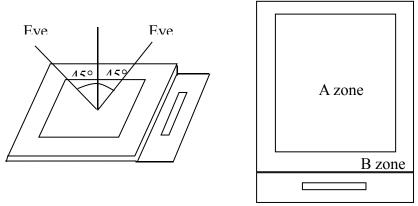
#### 1. Purpose

This standard for Quality Assurance assures the quality of LCD module products supplied to customer by Midas display.

### 2. Agreement Items

Midas and customer shall negotiate if the following situation occurs:

- 2.1 Additional requirement to be added in product specification.
- 2.3 Any other special problem.
- 3. Standard of the Product Visual Inspection
- 3.1 Appearance inspection:
- 3.1.1 The inspection must be under illumination about 1000 1500 lx, and the distance of view must be at  $30\text{cm} \pm 2\text{cm}$ .
- 3.1.2 The viewing angle should be 45° from the vertical line without reflection light or follows customer's viewing angle specifications.
  - 3.1.3 Definition of area: A Zone: Active Area, B Zone: Viewing Area.



3.2 Basic principle: A set of sample to indicate the limit of acceptable quality level must be discussed by both Midas and customer when there is any dispute happened.

## 4. Inspection Specification

Sampling plan according to GB/T2828.1-2012/ISO 2859-1: 1999 and ANSI/ASQC

Z1.4-1993, normal level 2 and based on:

Major defect: AQL 0.65 Minor defect: AQL 1.5

No.	Item	Criteria (Unit: mm)				
		a	Size	Area Acc. Qty		
	Black / White spot	-	φ≤0.10	Ignore		
	Foreign material		0.10<φ≤0.1	15 2		
01	(Round type)		0.15<φ≤0.2			
01	Pinholes Stain	1.	0.20<φ	0		
	Particles inside cell.	( 1) /2	Total	2 no include		
	(Minor defect)	$\varphi = (a + b)/2$		φ≤ 0.10		
		Distance between	2 defects should more t	han 5mm apart.		
	DESIGN • N  Black and White line	MANUX M L	L	FUPPLY		
02	Scratch Foreign material	Length	Width	Acc. Qty		
~~	(Line type)	/	W ≤ 0.03	Ignore		
	(Minor defect)	L ≦ 2	$0.03 < W \le 0.05$	1		
		/	0.05 < W	0		
			Total	1		
	Distance between 2 defects should more than 3mm apart. Scratches not viewable through the back of the display are acceptable.					

No.	Item	Criteria (Unit: mm)			
03	Glass Crack (Minor defect)	LCD with extensible crack line is unacceptable(When press the cracked LCD area, the line will expand, we define it is extensible crack line)			
04	Glass Chipping Pad Area: (Minor defect)	Length and Width Acc. Qty c < 5.0, b< 0.4 Ignore			
05	Glass Chipping Rear of Pad Area: (Minor defect)	Length and Width Acc. Qty $c > 3.0, b < 1.0 \qquad 1$ $c < 3.0, b < 1.0 \qquad 2$ $A c < 3.0, b < 0.5 \qquad 4$ $a < Glass Thickness$			
06	Glass Chipping Except Pad Area: (Minor defect)	Length and Width Acc. Qty   c ≤0.6, b< 5.0			

No.	Item	Criteria (Unit: mm)			
07	Glass Corner Chipping: (Minor defect)	Length and WidthAcc. Qtyc < 2.0, b< 1.5			
08	Glass Burr: (Minor defect)	Glass burr don't affect assemble and module dimension.  Length Acc. Qty			
		F < 0.5 Ignore			
09	FPC Defect: (Minor defect)	9.1 Dent, pinhole width a <w (w:="" 3.="" 9.2="" 9.3="" and="" circuit="" circuitry="" contamination="" distortion.<="" is="" no="" open="" oxidation,="" td="" unacceptable.="" width.)=""></w>			
10	Bubble on Polarizer (Minor defect)	$\begin{array}{c cc} Diameter & Acc. Qty \\ \hline \phi \leq 0.10 & Ignore \\ \hline 0.1 < \phi \leq 0.2 & 1 \\ \hline 0.2 < \phi & None \\ \end{array}$			
11	Dent on Polarizer (Minor defect)	$\begin{array}{c cc} Diameter & Acc. \ Qty \\ \hline \phi \leq 0.10 & Ignore \\ \hline 0.1 < \phi \leq 0.2 & 1 \\ \hline 0.2 < \phi & None \\ \end{array}$			
12	Bezel	12.1 No rust, distortion on the Bezel. 12.2 No visible fingerprints, stains or other contamination.			

No.	Item	Criteria (Unit: mm)		
	Touch Panel	D: Diameter W: width L: length		
		13.1 Spot: D≤0.20 is acceptable		
		0.20 <d≤0.3, 3<="" acceptable="" qty,="" td=""></d≤0.3,>		
		2dots are acceptable and the distance between defects should more		
		than 10 mm.		
13		D>0.3 is unacceptable		
		13.2 Dent: D>0.30 is unacceptable		
		13.3 Scratch: W≤0.03, L≤10 is acceptable,		
		0.03 <w≤0.10, ,acceptable="" 3<="" l≤10="" qty,="" td=""></w≤0.10,>		
		Distance between 2 defects should more than 10 mm.		
		W>0.10 is unacceptable.		
	PCB	14.1 No distortion or contamination on PCB terminals.		
14		14.2 All components on PCB must same as documented on		
14		the BOM/component layout.		
		14.3 Follow IPC-A-600F.		
15	Soldering	Follow IPC-A-610C standard		
	Electrical Defect (Major defect)	The below defects must be rejected.		
		16.1 Missing vertical / horizontal segment,		
		16.2 Abnormal Display.  16.3 No function or no display.		
		16.4 Current exceeds product specifications.		
		16.5 LCD viewing angle defect.		
		16.6 No Backlight.		
1.6		16.7 Dark Backlight. 16.8 Touch Panel no function.		
16		16.9 Dark Dot –one Allowed.		
		16.10 Bright Dot – one Allowed.		
		Remark:		
		1. A pixel defect is acceptable if one color is none functional and		
		causes a bright dot. The display may have one case where one		
		color is out and cause a dark dot.		
		2. Bright dot caused by scratch and foreign object accords to		
		item1.		

Remark: Visual and cosmetic defects are rejectable only if these fall within the LCD viewing area.

#### 5. Classification of Defects

Visual defects (Except no / wrong label are treated as minor defect and electrical defect is major.

#### 6. Identification/marking criteria

Any unit with illegible / wrong /double or no marking/ label shall be rejected.

### 7. Packing

- 7.1 There should be no damage of the outside carton box, each packaging box should has label in the correct location per packing drawing requirement.
- 7.2 All direct package materials shall offer ESD protection.

## **Reliability Specification**

Item	Condition	Cycle Time	Quantity	Remark	
Constant Temp. and Constant Humidity Operation Test	$+40 \pm 3$ °C,90 $\pm 3$ %RH	120hrs	-		
High Temp. Operation Test	+70 ± 3°C	120hrs		*1	
Low Temp. Operation Test	$-20 \pm 3^{\circ}\text{C}$	120hrs			
Thermal Shock Test	-20 ± 3°C (30min) +70 ± 3°C (30min)	10cycles	10		
ESD Test(end product)	150pF, 330Ω, ±2KV, Contact 150pF, 330Ω, ±6KV, Air	10times		*2, *3	
(for packaging)	Frequency: 10Hz to 55Hz to 10Hz,Swing:1.5mm,time: X,Y,Z each 2H.	6hrs	One inner carton	*4	

Note 1. For humidity test, DI water should be used.

Inspection Standard: Inspect after 1-2hrs storage at room temperature, the sample shall be free from the following defects:

- Air bubble in the LCD
- Seal Leakage
- Non-display
- Missing Segment
- Glass Crack
- IDD is greater than twice initial value.
- Others as per QA Inspection Criteria

Note 2. No defect is allowed after testing

The End Product ESD value is only indicative and depends on customer ESD

protection design for the whole system.

Note 3. ESD should be applied to LCD glass panel, not other areas (such as on IC and so on) IDD should be within twice initial value.

In case of malfunction defect caused by ESD damage, if it would be recovered to normal state after resetting, it would be judged as a good part.

Note 4. Only upon request.

### **Precautions and Warranty**

### 1. Safety

- 1.1 The liquid crystal in the LCD is poisonous. Do not put it in your mouth. If the liquid crystal touches your skin or clothes, wash it off immediately using soap and water.
- 1.2 Since the liquid crystal cells are made of glass, do not apply strong impact on them. Handle with care.

#### 2. Handling

- 2.1 Reverse and use within ratings in order to keep performance and prevent damage.
- 2.2 Do not wipe the polarizer with dry cloth, as it might cause scratch. If the surface of the LCD needs to be cleaned, wipe it swiftly with cotton or other soft cloth soaked with petroleum IPA, do not use other chemicals.

#### 3. Operation

- 3.1 Do not drive LCD with DC voltage
- 3.2 Response time will increase below lower temperature
- 3.3 Display may change color with different temperature
- 3.4 Mechanical disturbance during operation, such as pressing on the display area, may cause the segments to appear "fractured".

#### 4. Static Electricity

- 4.1 CMOS LSIs are equipped in this unit, so care must be taken to avoid the electro-static charge, by ground human body, etc.
  - 4.2 The normal static prevention measures should be observed for work clothes and benches.
- 4.3 The module should be kept into anti-static bags or other containers resistant to static for storage.

#### 5. Limited Warranty

5.1 Unless otherwise agreed between Midas and customer, Midas will replace or repair any of its LCD and LCM which Midas found to be defective electrically and visually when inspected in accordance with Midas Quality Standards, for a period of one year from date of shipment.

- 5.2 The warranty liability of Midas is limited to repair and/or replacement. Midas will not be responsible for any consequential loss.
- 5.3 If possible, we suggest you use up all modules in six months. If the module storage time over twelve months, we suggest that recheck it before the module be used.

### **Prior Consult Matter**

- 1. For Midas standard products, we keep the right to change material, process for improving the product property without prior notice to our customer.
- 2. For OEM products, if any changes are needed which may affect the product property, we will consult with our customer in advance.
- 3. If you have special requirement about reliability condition, please let us know before you start the test on our samples.

DISPLAYS

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